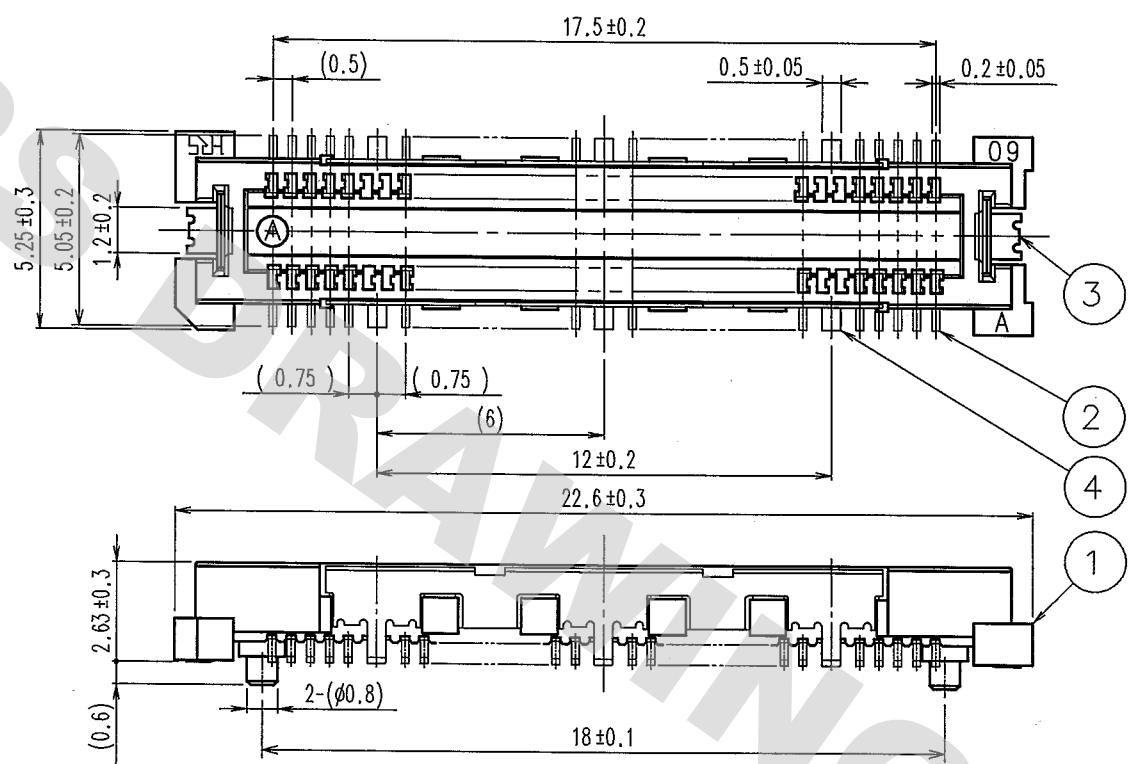
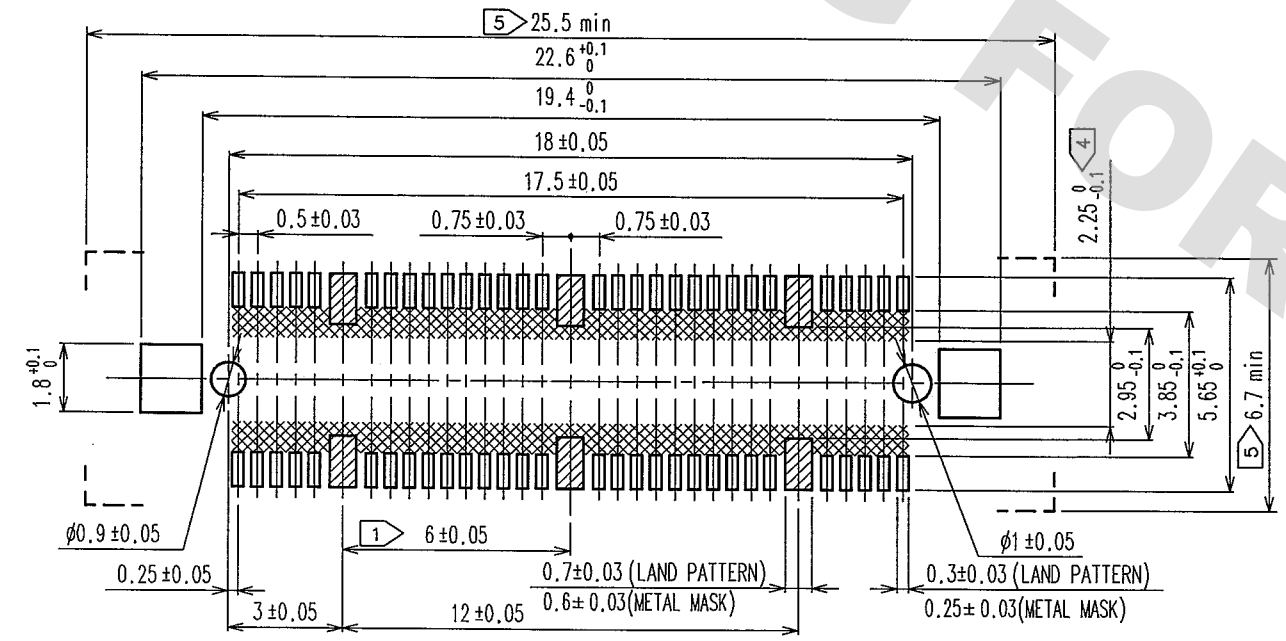


DRAWING FOR REFERENCE: This is subject to change without notice
08/11/2012

TO

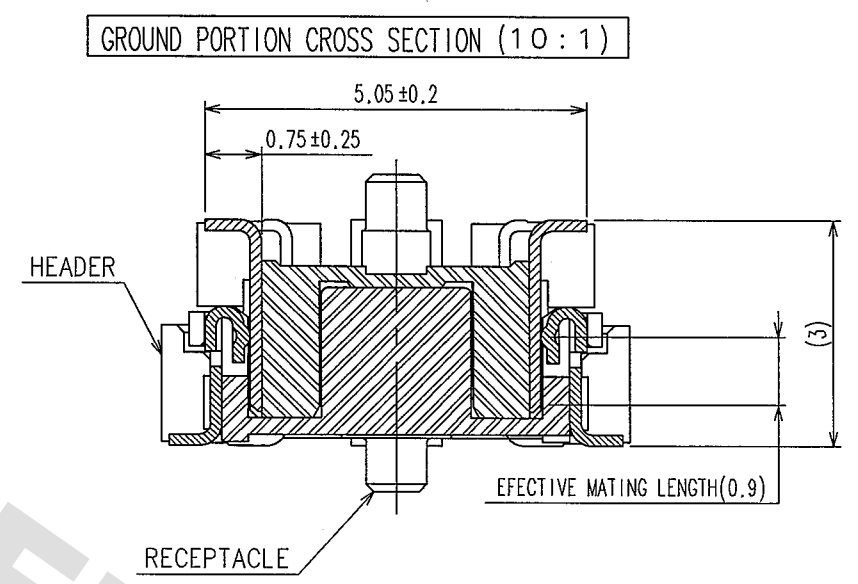
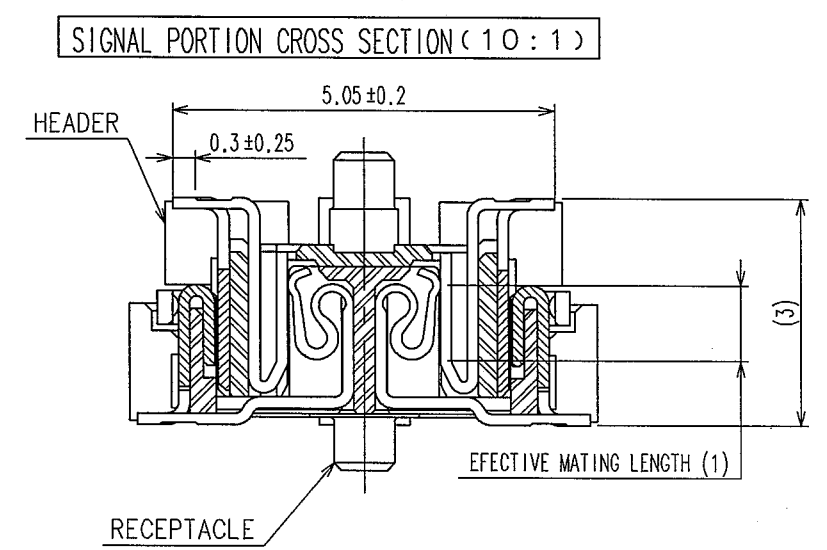


RECOMMENDED LAND PATTERN DIMENSION OF PCB



- NOTES
- 1 6 HATCHED PARTS: GROUND CIRCUIT.
 - 2 SMT LEAD-COPLANARITY: 0.1 MAX.
 - 3 THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
 - 4 MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND, OR LEAD MAY TOUCH PATTERN. (THIS APPLIES TO HATCHED AREA.)
 - 5 DO NOT MOUNT OTHER DEVICES ONTO AREA, OR MATING PAIR CANNOT BE MATED.
 - 6 DIMENSION IN PARENTHESES ARE FOR REFERENCE.

COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE	COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE



3,4	PHOSPHOR BRONZE	TIN PLATING	2	COPPER ALLOY	CONTACT AREA : GOLD 0.1μm min.
1	LCP	BEIGE UL94V-0			MOUNTING AREA : GOLD FLASH
					UNDER PLATING : NICKEL 1μm min.
NO.	MATERIAL	FINISH, REMARKS	NO.	MATERIAL	FINISH, REMARKS
CODE NO. (OLD)	CL	DRAWN	DESIGNED	CHECKED	APPROVED
		T. YANAGISAWA	J. Mada	K. Ogawa	H. Okawa
		'05.10.11	'05.10.12	'05.10.12	'05.10.12
SCALE	5 : 1	DRAWING NO.	EDC3-152614-25	PART NO.	FX11A-60P/6-SV0.5(71)
UNITS	mm	CODE NO.	CL573-0602-4-71		1/1